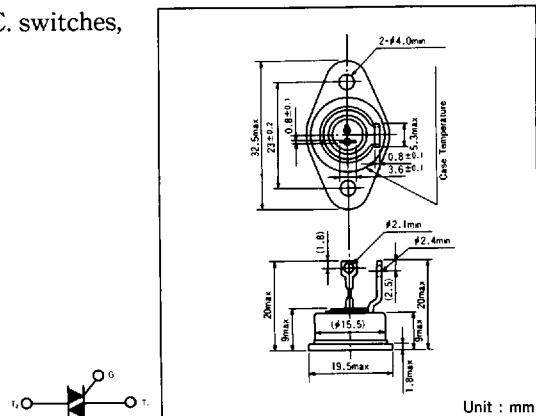


SSG16C-Y

For general A.C. power control applications such as A.C. switches, light controls, speed controls and heater controls etc.

- General A.C. power use
- $I_{T(RMS)} = 16A$
- High voltage up to 1200V
- High surge current of 160A
- Package types; diamond

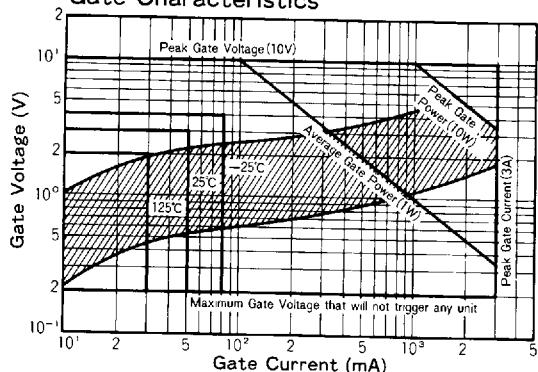
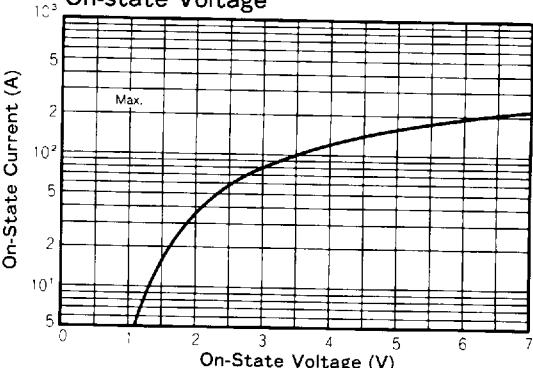
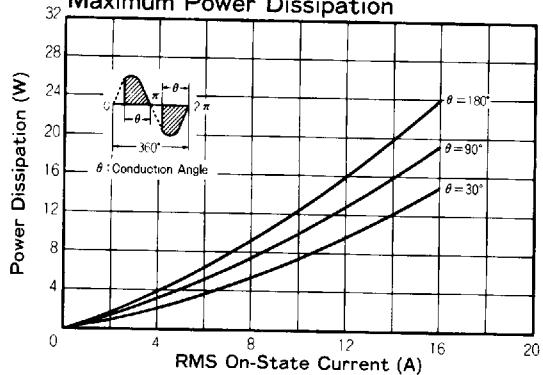
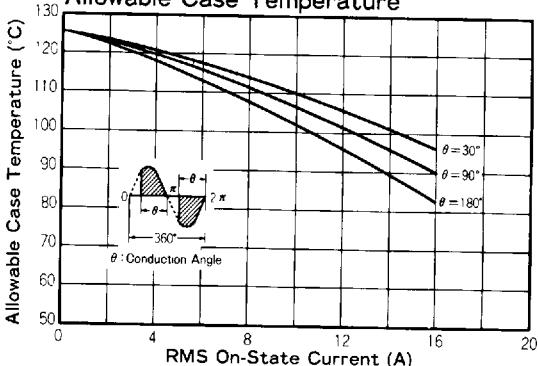
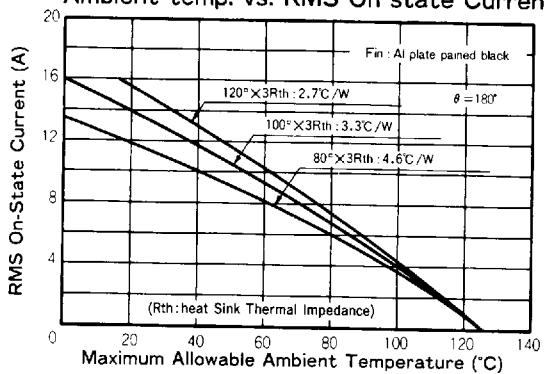
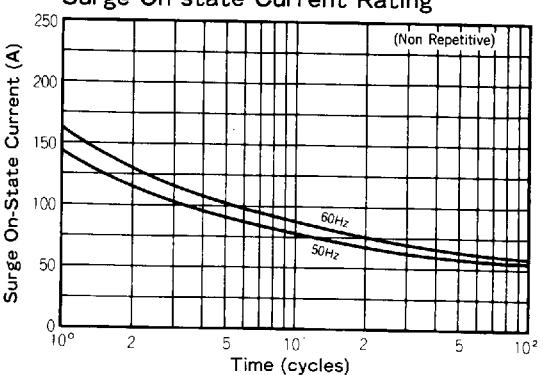
**Maximum Ratings**

Symbol	Item	SSG16C40Y	SSG16C60Y	SSG16C80Y	SSG16C100Y	SSG16C120Y	Unit
V_{DRM}	Repetitive Peak off-State Voltage	400	600	800	1000	1200	V

Symbol	Item	Conditions	Ratings	Unit
$I_{T(RMS)}$	R.M.S On-State Current	$T_c = 82^\circ C$	16	A
I_{TSM}	Surge On-State Current	One cycle, 50/60Hz, peak, non-repetitive	140/160	A
I^2t	I^2t	Value for one cycle of surge current	106	A^2S
P_{GM}	Peak Gate Power Dissipation		10	W
$P_{G(AV)}$	Average Gate Power Dissipation		1	W
I_{GM}	Peak Gate Current		3	A
V_{GM}	Peak Gate Voltage		10	V
di/dt	Critical Rate of Rise of On-State Current	$I_G = 100mA, T_j = 25^\circ C, V_D = \frac{1}{2}V_{DRM}, dI_G/dt = 1A/\mu s$	50	$A/\mu s$
V_{iso}	Isolation Breakdown Voltage(R.M.S)	A.C. 1minute	2500	V
T_j	Operating Junction Temperature		-25~+125	$^\circ C$
T_{stg}	Storage Temperature		-25~+125	$^\circ C$
	Mounting Torque	Recommended Value 8kgf·cm	10	$kgf\cdot cm$
	Mass	Excluding bolt, nut and wrapping material	10.3	g

Electrical Characteristics

Symbol	Item	Conditions	Ratings	Unit
I_{DRM}	Repetitive Peak Off-State Current, max.	at V_{DRM} , single phase, half wave, $T_j = 125^\circ C$	3	mA
V_{TM}	Peak On-State Voltage, max.	$I_T = 25A, T_j = 125^\circ C$ Inst. measurement	1.7	V
I_{GT1}^+ 1	Gate Trigger Current, max.	$T_j = 25^\circ C, I_T = 1A, V_D = 6V$	50	mA
I_{GT1}^- 2		$T_j = 25^\circ C, I_T = 1A, V_D = 6V$	50	
I_{GT3}^+ 3			—	
I_{GT3}^- 4		$T_j = 25^\circ C, I_T = 1A, V_D = 6V$	50	
V_{GT1}^+ 1	Gate Trigger Voltage, max.	$T_j = 25^\circ C, I_T = 1A, V_D = 6V$	3	V
V_{GT1}^- 2		$T_j = 25^\circ C, I_T = 1A, V_D = 6V$	3	
V_{GT3}^+ 3			—	
V_{GT3}^- 4		$T_j = 25^\circ C, I_T = 1A, V_D = 6V$	3	
V_{GD}	Non-Trigger Gate Voltage, min.	$T_j = 125^\circ C, V_D = \frac{1}{2}V_{DRM}$	0.2	V
tgt	Turn On Time, max	$I_T = 16A, I_G = 100mA, V_D = \frac{1}{2}V_{DRM}, T_j = 25^\circ C, dI_G/dt = 1A/\mu s$	10	μs
dv/dt	Critical Rate of Rise of On-State Voltage, min.	$T_j = 125^\circ C, V_D = \frac{2}{3}V_{DRM}$, Exponential wave.	50	$V/\mu s$
$(dv/dt)_c$	Critical Rate of Rise off-State Voltage at commutation, min	$T_j = 125^\circ C, (dv/dt)_c = 8A/ms, V_D = \frac{2}{3}V_{DRM}$	6	$V/\mu s$
I_h	Holding Current, typ.	$T_j = 25^\circ C$	30	mA
$R_{th(j-c)}$	Thermal Impedance, max.	Junction to case	1.8	$^\circ C/W$

Gate Characteristics**On-state Voltage****On state Current vs. Maximum Power Dissipation****On state Current vs. Allowable Case Temperature****Ambient temp. vs. RMS On state Current****Surge On state Current Rating****Transient Thermal Impedance**